



**BRIDGE RECTIFIERS** 

REVERSE VOLTAGE - 50 to 1000Volts FORWARD CURRENT - 1.0 Ampere



DF-S

**DF005S - DF10S** 

DFS SURFACE MOUNT GLASS PASSIVATED RoHS compliant

## **FEATURES:**

- 1. Rating to 1000V PRV
- 2. Ideal for printed circuit board
- 3. Low forward voltage drop, high current capability
- 3. Reliable low cost construction utilizing molded plastic technique results in inexpensive product
- 4. The plastic material has UL flammability classification 94V-0

**APPLICATIONS:** Power Supplies, Mobile Charger, LED drivers

## **ABSOLUTE MAXIMUM RATING** (Ta = 25 °C Unless otherwise specified)

PARAMETERS		SYMBOL	DF0 05S	DF 01S	DF 02S	DF 04S	DF 06S	DF 08S	DF 10S	UNITS
Maximum repetitive peak reverse voltage		$V_{RRM}$	50	100	200	400	600	800	1000	VOLTS
Maximum RMS voltage		$V_{RMS}$	35	70	140	280	420	560	700	VOLTS
Maximum DC blocking voltage		$V_{DC}$	50	100	200	400	600	800	1000	VOLTS
Maximum Average Forward Rectified Current @TA=40°C		I <sub>(AV)</sub>	1.0					Amp		
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load		I <sub>FSM</sub>	30.0				Amp			
Rating for fusing (t=8.3ms, Ta=25° C)		l <sup>2</sup> t	10.40				Amp			
Maximum Forward Voltage at 1.0A DC		$V_{F}$	1.10			VOLTS				
Maximum DC reverse	T <sub>A</sub> =25°C		10.0						μА	
current at rated DC blocking voltage	T <sub>A</sub> =125°C	I <sub>R</sub>	500							
Typical junction capacitance (Note 1)		CJ	25.0		pF					
Typical thermal resistance (Note2)		$R_{\theta JA}$	40.0			°C/W				
Operating junction and storage		$T_J, T_{STG}$	-55 to +155		°C					

#### Note:

- 1.Measured at 1.0MHz and applied reverse voltage of 4.0V DC
- 2.Thermal resistance from junction to ambient mounted on P.C.B with 0.5\*0.5"(13\*13mm) copper pads.

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# **Typical Characteristic curves**

Fig 1: Forward Current Derating Curve

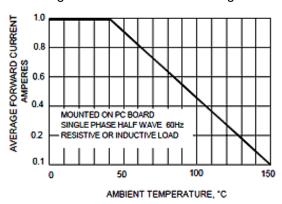


Fig 2: Typical Junction Capacitance

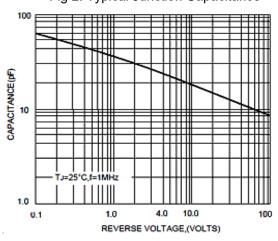


Fig 3: Typical Reverse Characteristics

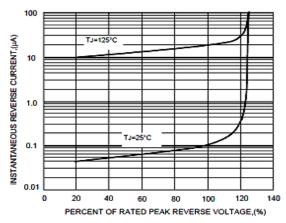


Fig 4: Maximum Non-Repetitive Surge Current

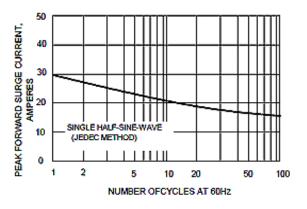
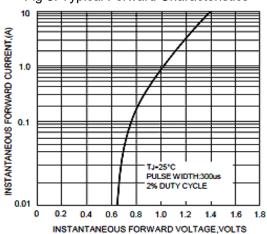


Fig 5: Typical Forward Characteristics



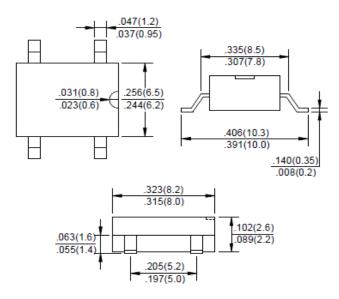
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# **Package Details**

# Package:DFS



Dimensions in inches and (millimeters)

## **MECHANICAL DATA**

- 1. Polarity: As marked on Body
- 2. Weight: 0.02 ounces, 0.38 grams
- 3. Mounting position: Any







# Recommended Product Storage Environment for Discrete Semiconductor Devices

This storage environment assumes that the Diodes and transistors are packed properly inside the original packing supplied by CDIL.

- · Temperature 5 °C to 30 °C
- · Humidity between 40 to 70 %RH
- · Air should be clean.
- · Avoid harmful gas or dust.
- · Avoid outdoor exposure or storage in areas subject to rain or water spraying .
- · Avoid storage in areas subject to corrosive gas or dust. Product shall not be stored in areas exposed to direct sunlight.
- · Avoid rapid change of temperature.
- · Avoid condensation.
- · Mechanical stress such as vibration and impact shall be avoided.
- · The product shall not be placed directly on the floor.
- · The product shall be stored on a plane area. They should not be turned upside down.

They should not be placed against the wall.

## **Shelf Life of CDIL Products**

The shelf life of products is the period from product manufacture to shipment to customers. The product can be unconditionally shipped within this period. The period is defined as 2 years. If products are stored longer than the shelf life of 2 years the products shall be subjected to quality check as per CDIL quality procedure.

The products are further warranted for another one year after the date of shipment subject to the above conditions in CDIL original packing.

## Floor Life of CDIL Products and MSL Level

When the products are opened from the original packing, the floor life will start. For this, the following JEDEC table may be referred:

JEDEC MSL Level						
Level	Time	Condition				
1	Unlimited	≤30 °C / 85% RH				
2	1 Year	≤30 °C / 60% RH				
2a	4 Weeks	≤30 °C / 60% RH				
3	168 Hours	≤30 °C / 60% RH				
4	72 Hours	≤30 °C / 60% RH				
5	48 Hours	≤30 °C / 60% RH				
5a	24 Hours	≤30 °C / 60% RH				
6	Time on Label(TOL)	≤30 °C / 60% RH				







### **Customer Notes**

### **Component Disposal Instructions**

- 1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
- 2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

## **Disclaimer**

The product information and the selection guides facilitate selection of the CDIL's Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).

CDIL strives for continuous improvement and reserves the right to change the specifications of its products without prior notice.



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